



Attorney/Docket No. 34003.110  
Customer No. 000027683

IFW

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:  
Rahul Saini et al.

Serial No.: 10/799,836

Filed: March 12, 2004

For: Compact Microcolumn For Automated Assembly

§  
§ Group Art Unit: 2879  
§  
§  
§ Examiner: unknown  
§  
§ Confirmation No.: 8482  
§

INFORMATION DISCLOSURE STATEMENT

Mail Stop Amendment  
Commissioner For Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450


Dear Sir:

In compliance with the duty of disclosure under 37 CFR §1.56, and in accordance with the practice under 37 CFR §1.97 and §1.98, the Examiner's attention is directed to the documents listed on the enclosed modified Form PTO-1449. No inference should be made that the cited references are in fact material, are in fact prior art, or that no better art exists. The cited patents are listed in numerical order and are not in any order based on their pertinence. Copies of the listed references are attached.

It is respectfully requested that the Examiner fully consider the cited references and issue an early action on the merits, the references be cited on the front of any patent issuing from this application and that a copy of the enclosed Form PTO-1449 be returned indicating that such information has been considered.

The Commissioner is hereby authorized to charge any additional fees which may be required or credit any overpayment to Deposit Account 08-1394.

Respectfully submitted,

  
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Date: 12/21/04  
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I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to Commissioner For Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on 12-23-04.

Karen L. Underwood  
Printed Name  
Karen L. Underwood  
Signature



FOREIGN PATENT DOCUMENTS					
Examiner's Initials	Cite No.	Foreign Patent Document (Country Code – Number – Kind)	Publication Date MM-DD-YYYY	Patentee or Applicant of Cited Document	Translation Y/N

NON-PATENT LITERATURE DOCUMENTS		
Examiner's Initials	Cite No.	Include name of the author (in CAPITAL LETTERS), title of the article, title of the item, date, page(s), volume-issue number(s), publisher, city/country where published
	A3	Dechev et al., "Microassembly of 3-D Microstructure Using a Compliant, Passive Microgripper," Journal of Microelectromechanical Systems, Vol. 13, No. 2, April 2004, pages 176-189.
	A4	Tsui et al., "Micromachined end-effector and techniques for directed MEMS assembly," Journal of Micromechanics and Microengineering, Institute of Physics Publishing, United Kingdom 2004, pages 1-8.
	A5	Ellis, et al., "High aspect ratio silicon micromechanical connectors", High Aspect Ratio Micro-Structure Technology Workshop, June 15-17, 2003, Monterey, California USA.
	A6	M. Szilagyi et al., "Synthesis of Electrostatic Focusing and Deflection Systems", JVST B 15(6), Nov/Dec 1997, pp 1971

EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include a copy of this form with next communication to applicant.